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# Muon Collider Magnet Technology Options Internal Review

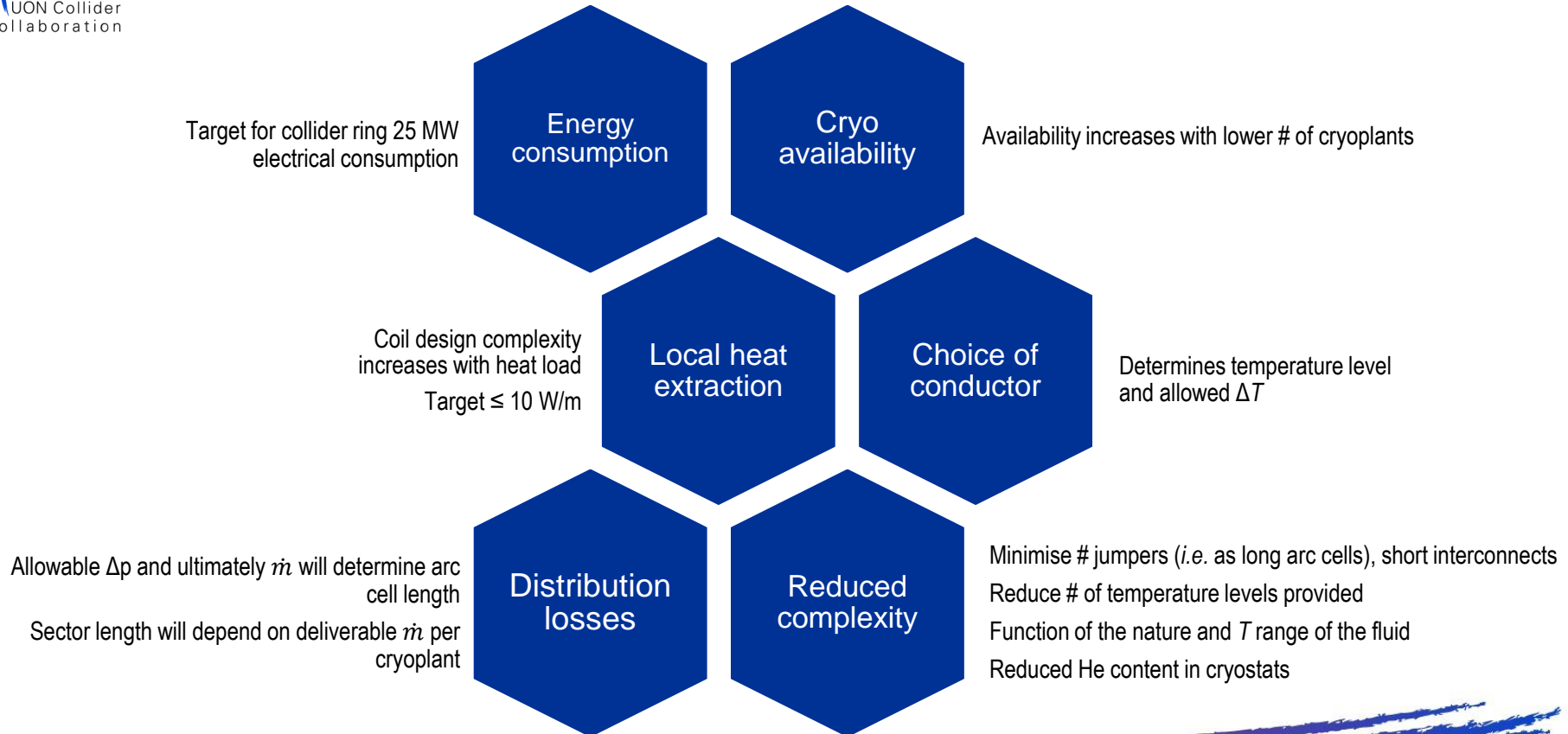
## Cooling

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IMCC Annual Meeting 2023

19<sup>th</sup> to 22<sup>nd</sup> June 2023, Orsay, France

# Cooling options – main drivers

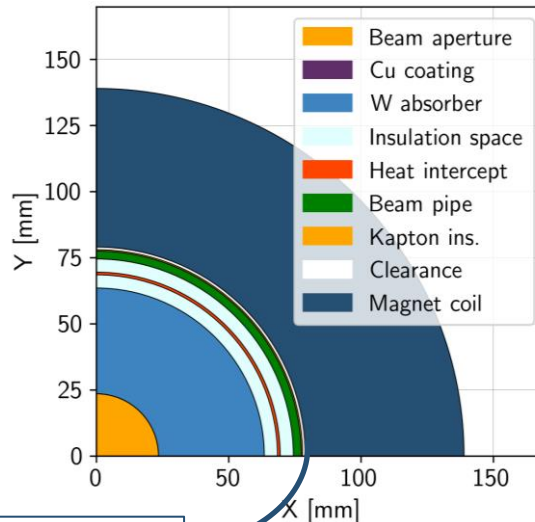


# Updated radial build for collider arc magnets

- Radial build has evolved to include a **heat intercept** between the absorber and the coil

- Beam aperture ( $5\sigma$ )
  - Cu layer beam screen
  - Tungsten absorber
  - Insulation space
  - Heat intercept
  - Insulation space
  - Beam pipe
  - Kapton insulation
  - Clearance
  - Coil pack\*
- \*thickness TBD, placeholder

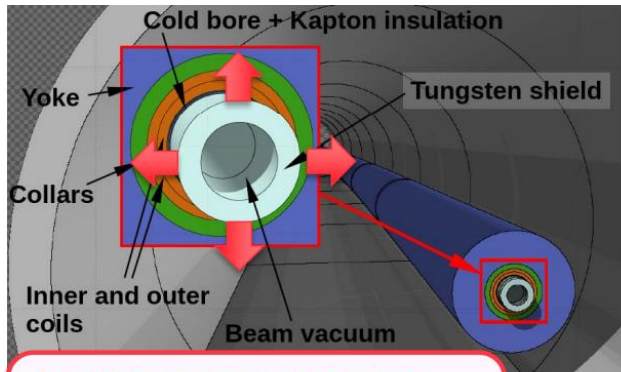
23.5 mm radius  
0.01 mm thick  
40 mm thick  
5 mm thick  
1 mm thick  
5 mm thick  
3 mm thick  
0.5 mm thick  
1 mm thick  
(60 mm thick)



Coil aperture 158 mm

# Updated radial build for collider arc magnets

- Radial build has evolved to include a **heat intercept** between the absorber and the coil
- Baseline for heat load estimation/power consumption is **10 TeV machine**



- ❖ Fraction of power leaking through shielding similar for 3 TeV & 10 TeV
- ❖ This power is mostly deposited in cold mass (including cold bore)

	To absorber	To cold mass		
		Power penetrating shielding		
	Power carried by decay $e^-/e^+$ :	2 cm	3 cm	4 cm
3 TeV	410 W/m	14 W/m	6 W/m	3 W/m
10 TeV	500 W/m	18 W/m	8 W/m	4 W/m



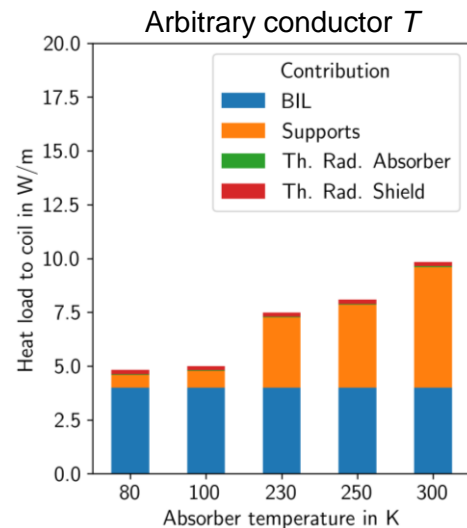
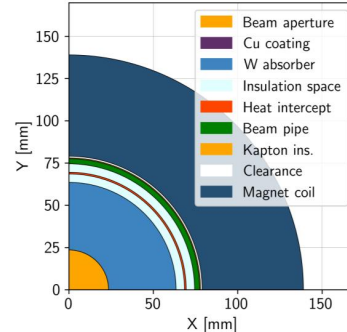
From muon decay; total heat load will include substantial contributions, e.g. conduction, thermal radiation...

# Heat load deposited at cold mass level

## w/ heat intercept

- Heat load estimated considering a heat intercept (between coil and absorber) and a thermal shield external to the cold mass at 80 K, and as a function of:
  - Coil temperature;
  - Absorber temperature;
  - Absorber thickness.
- Note:** absorber is not considered to be part of the cold mass
- Heat load  $\sim$  independent of coil  $T$  (cooling effort heavily does, see next slide)
- Heat intercept cuts heat load by (thermal) radiation from the absorber to negligible values (total heat load doubles without it)
- Contribution from absorber supports considered disproportionate w.r.t. unavoidable beam-induced loads for  $T_{abs} \geq 100$  K

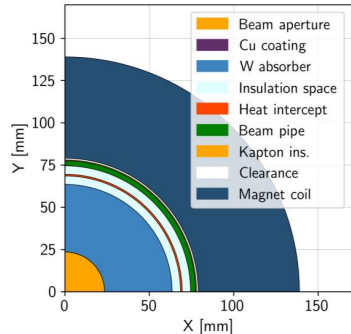
**Target:** Heat load to coil  $\leq 10$  W/m



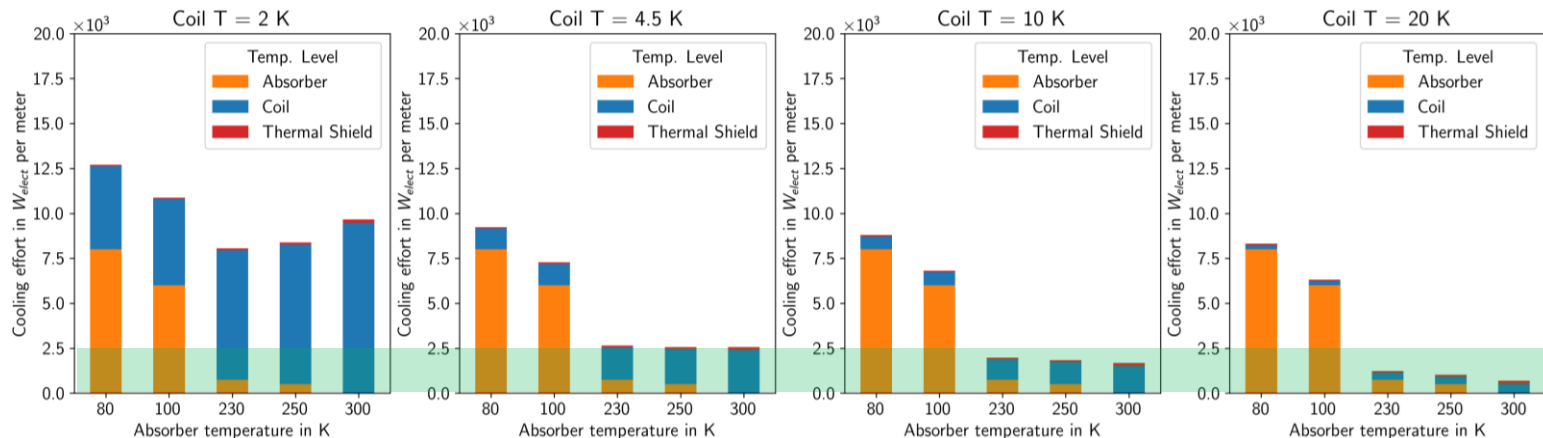
**Shown:** Heat load to coil in W/m, for heat intercept and thermal shield at 80 K, absorber thickness 4 cm, coil at 4.5 K

# Power consumption at refrigerator I/F

## w/ heat intercept



- Power consumption estimated for shown heat loads at various **coil** and **absorber temperatures**
- Different colours in the plots mean cooling effort at a different  $T$  level
- Not included: distribution losses, based purely on  $COP^{-1}$  (see spares)



Shown: Cooling effort at refrigerator I/F, absorber thickness 4 cm, shield and heat intercept 80 K

**Target:**  
25 MW for Cryo  
in collider  
(2.5 kW<sub>e</sub>/m)

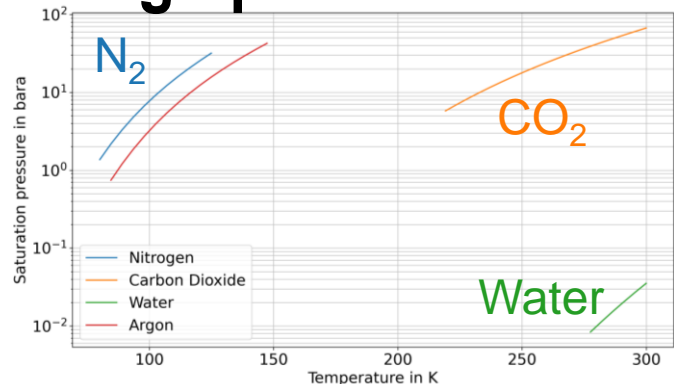
**Message:** 25 MW total for 10 km collider ring →

- $T_{coil} \geq 4.5 \text{ K}$
- $T_{abs} \geq 200 \text{ K}$

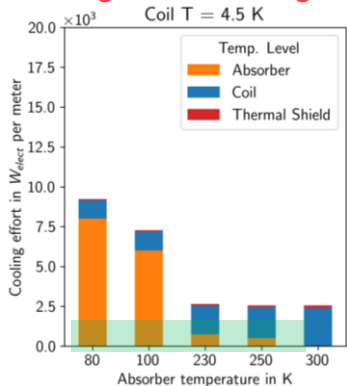
# Considerations for absorber cooling options

- From initial assumptions:

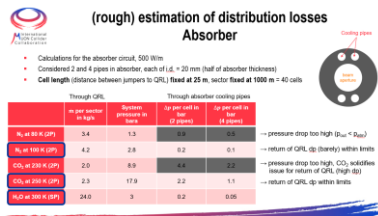
Absorber temperature: ~~80 K, 100 K, 230 K~~, 250 K, 300 K



Cooling effort too high



$\Delta p$  too high even for short cells, CO<sub>2</sub> solidifies (see spare slides)



T level	250 K	300 K
Fluid	CO <sub>2</sub>	Water
Mass flow rate	+	+/- (10x higher)
Operating pressure	+/- (60+ bara)	+ (3-10 bara)
$\Delta p$	+/-	+ (smaller pipes)
Heat transferred to coil	+	- (20% higher)
COP <sup>-1</sup>	+/-	+ (only distrib.)
Rad. hardness	+	- (mitigation needed)
Risks to machine	+	- (freezing; expansion)

**Message:**  $T_{abs} \geq 250$  K

# Considerations for coil cooling options

- **Cooling mode (and temperature)** will depend on the **choice of conductor**, which depends on the **maturity level** of the technology and on the **timescale of construction**

## 3 TeV machine

- Construction in ~15 years
- Magnetic fields within Nb<sub>3</sub>Sn capabilities
- Nb<sub>3</sub>Sn matured, usable
- Cooling at 4.5 K – 5.5 K using SC He
- Cooling at 4.5 K using He two-phase flow

## 10 TeV machine

- Construction in ~25-30 years
- HTS preferred for sustainable collider
- Needs development
- Cooling at 10 K – 15 K or above
- He or H<sub>2</sub> possible; in-depth study needed



# Considerations for coil cooling options

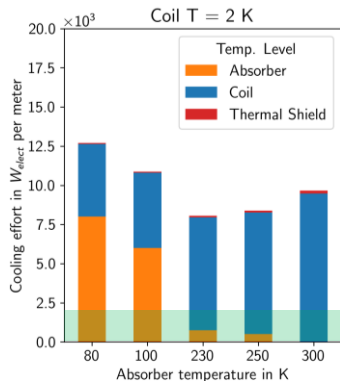
Options at  $T \leq 5.5$  K (Nb<sub>3</sub>Sn, 3 TeV machine)

Coil T: ~~2 K~~

4.5 K 2PF

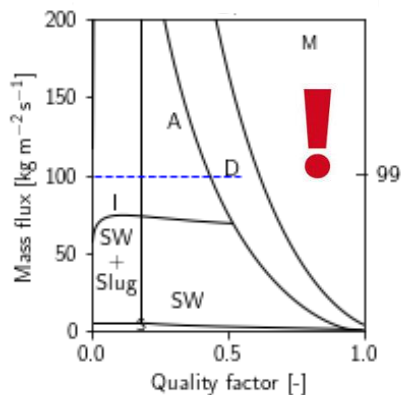
4.5 K sc

Cooling effort too high



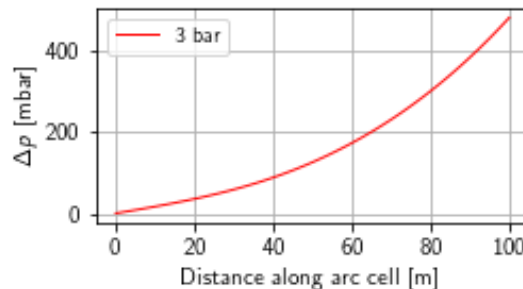
10 W/m, arc cell L=10 m,  
8 mm, 2 parallel pipes  
 $\dot{m}_{sector}=1000$  g/s, dp=20 mbar

Flow stability and control



10 W/m, arc cell L=100 m,  
13 mm, 2 parallel pipes  
 $\dot{m}_{sector}=500$  g/s, dp=500 mbar

Promising; no major showstopper  
identified so far



**Message:**  $T_{coil} \geq 4.5$   
K, supercritical cooling  
looks promising



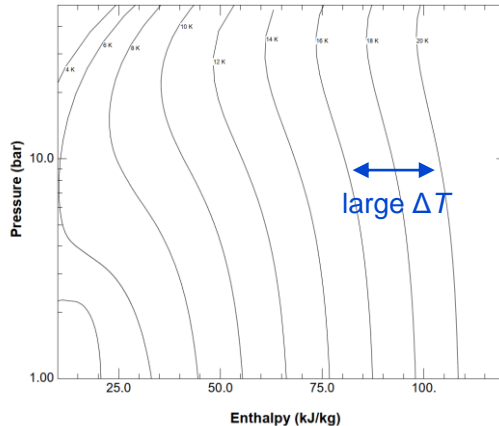
# Considerations for coil cooling options

## Options at $T \geq 10$ K (HTS, 10 TeV machine)

Coil  $T$ :  $\Delta T$  around 10 K,  $\Delta T$  around 20 K, 20 K 2PF

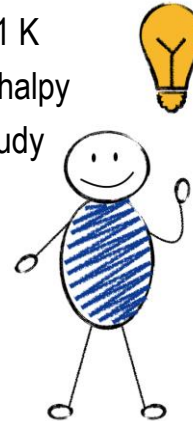
He gas cooling:

- Large  $\Delta T$ , 5 K - 10 K
- Heat transfer starts to break down



H<sub>2</sub> two-phase flow:

- Possible for  $T > 21$  K
- High available enthalpy
- Needs in-depth study

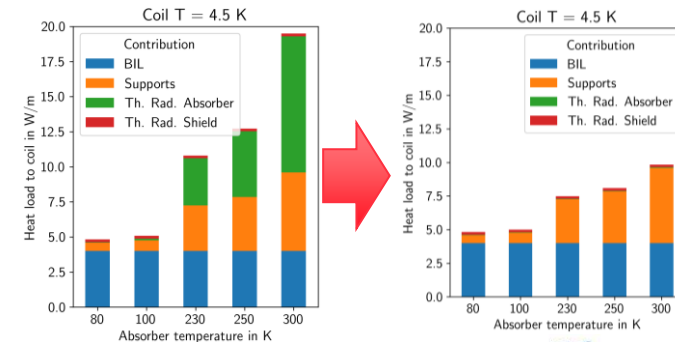
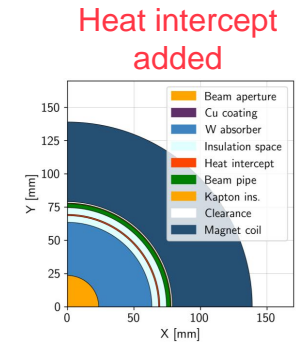
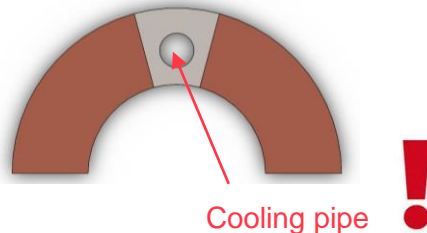


**Message:** above 4.5 K any He-based cooling involves a sizeable  $\Delta T$

# Evaluation of technology options for magnet cooling Collider Ring


## Done:

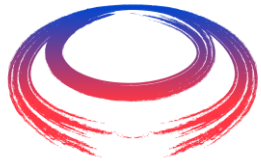
- Critical contributors to total heat load deposited on the coil identified
- Absorber must operate at or above 250 K (overall cooling effort, distr. losses)
- Heat intercept between coil and absorber is a necessity
- Electrical power consumption of collider ring cryogenics estimated
- Coil must operate at or above 4.5 K
- Preliminary evaluation of possible cooling schemes, limitations



# Evaluation of technology options for magnet cooling Collider Ring

## Needs attention:

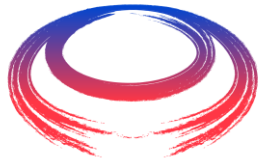
- 
- Contribution from absorber **supports** considered disproportionate → effort should be put into the design of an optimized support for the MC absorber conditions
  - Preliminary **cross-section of the coil** (and absorber) should be outlined to estimate max. cooling tube size, number, position → allows for some boundaries to cooling scheme layouts
  - **Cooling options for LTS** (around 5 K) examined, **promising** → need R&D to explore the limits of two-phase flow and supercritical cooling in confined geometries
  - **Cooling options for HTS** (if 10K+) **need in-depth study** → He gas cooling does not provide efficient heat transfer; H<sub>2</sub> cooling needs demonstration and change of mindset, safety assessment
  - **Cooling of absorber** with CO<sub>2</sub>/water needs in-depth review of the base assumptions, esp. risk-related
  - **Current leads:** neither heat loads nor cooling options have been addressed



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***Thank you for your attention***



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***Spare slides***

# Evaluation of technology options for magnet cooling

## Rest of the MC complex

### Accelerator ring:

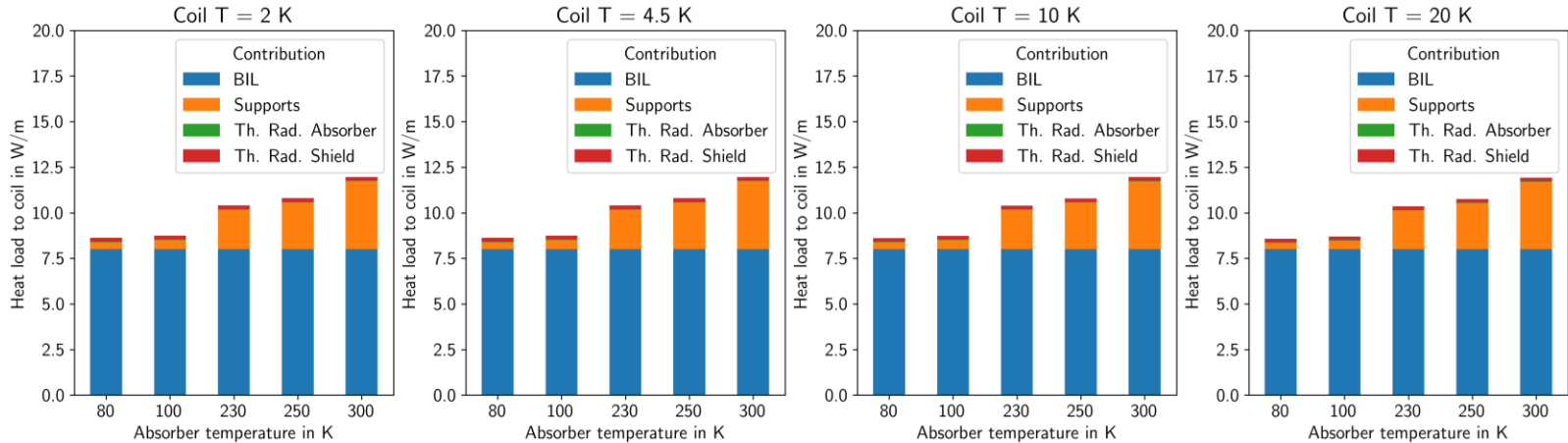
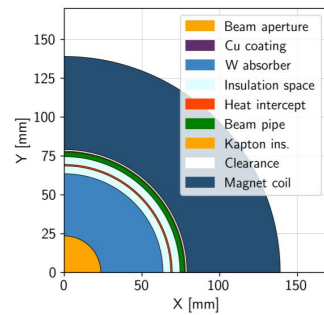
- Need to converge on a basic design for 3 TeV and/or 10 TeV to identify bottlenecks
- Special attention must be given to multiple cold-to-warm transitions, (very) short interconnect space
- Considerations on technology options investigated for collider ring, can be applicable to accelerator

### 6D cooling cell, target magnets:

- Specific magnets (interaction region magnets, target solenoid, cooling cell) need tailored, possibly less energy-optimized solutions – study to be carried out once preliminary specifications are fixed

# Heat load deposited at cold mass level w/ heat intercept

- Heat load at cold mass level  $f(T_{absorber}, T_{coil}, T_{thermal\ shield})$  shown for absorber thickness of **3 cm**, and considering outer thermal shield at 80 K
- With added heat intercept (shield) between the coil and the absorber**



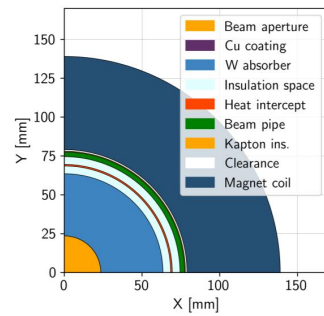
Heat intercept  
between coil  
and absorber!

- Reducing the absorber thickness from 4 cm to 3 cm **doubles** the beam-induced load that penetrates shielding (**blue part**) while only reducing the heat load via the supports (**orange part**, which is weight-dependent) by 30%



# Power consumption at refrigerator I/F

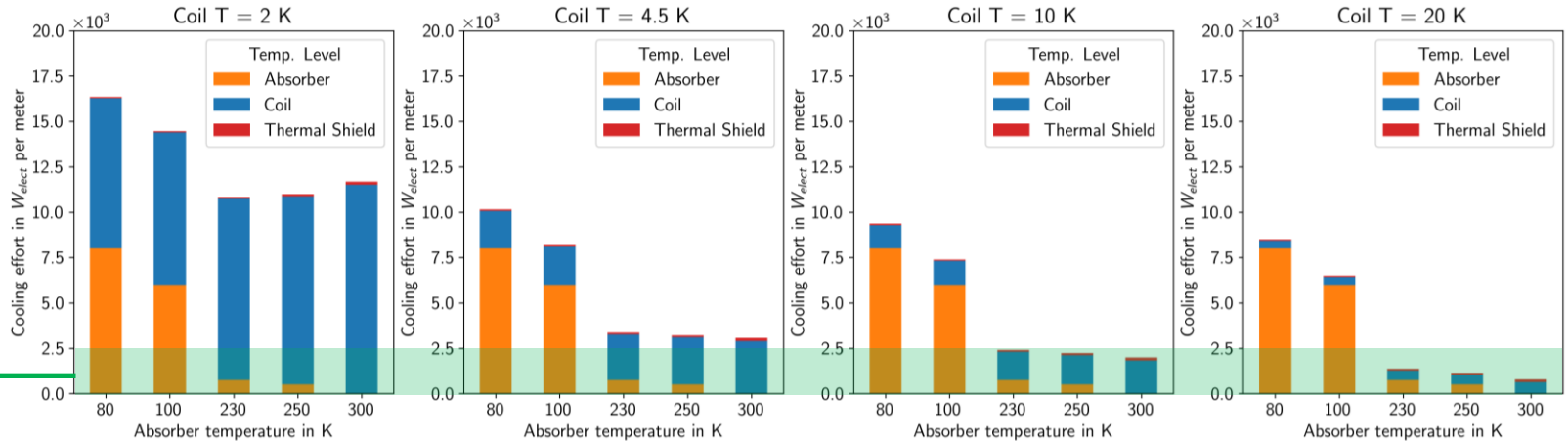
3 cm absorber, w/ heat intercept



Blue: electrical power required to provide cooling power at cold mass temp. level

Orange: electrical power required to provide cooling power at absorber temp. level

Red: electrical power required to provide cooling power at thermal shield temp. level



Target:  
25 MW for  
Cryo in  
collider

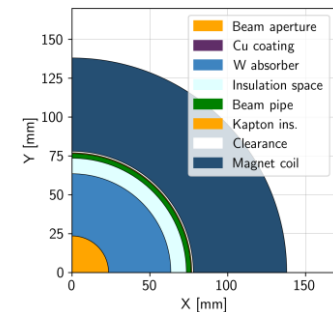
The larger the blue component → the more difficult the coil design

**N.B. I:** the cost to extract heat at 300 K is nearly zero, reflecting the fact that the distribution effort (circulation) is **not yet included**

**N.B. II:** although COP<sup>-1</sup> based on cryoplants using certain fluids, so far, we're talking only about temp. level, *i.e.*, no fluid-dependent costs considered (as distribution, special handling, etc...)

# Power consumption at refrigerator I/F

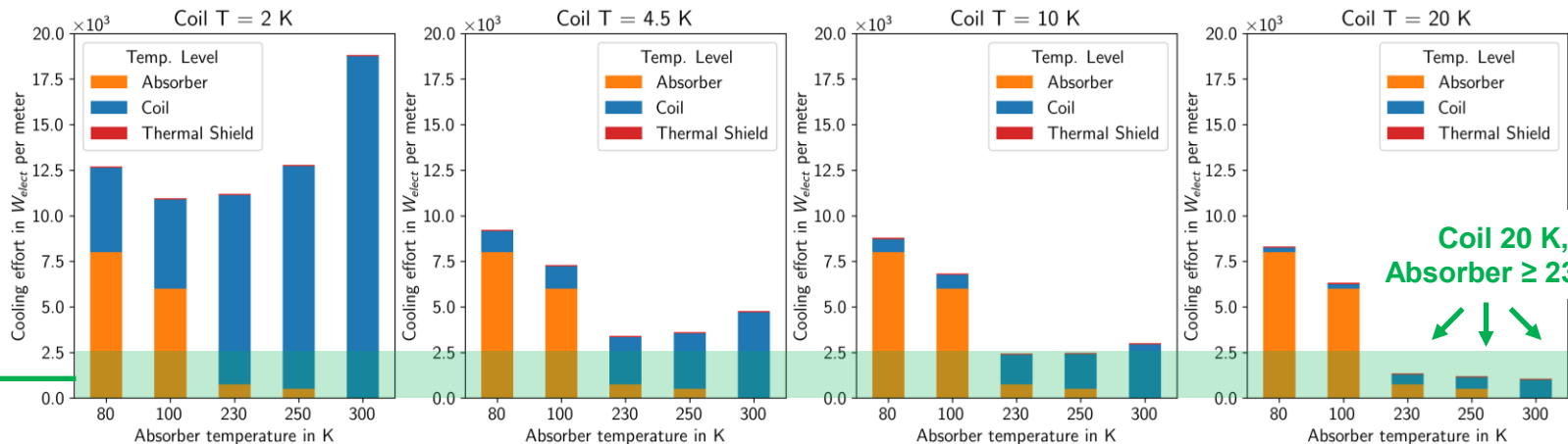
## 4 cm absorber, baseline



**Blue:** electrical power required to provide cooling power at **cold mass temp. level**

**Orange:** electrical power required to provide cooling power at **absorber temp. level**

**Red:** electrical power required to provide cooling power at **thermal shield temp. level**



The larger the **blue** component  $\rightarrow$  the more difficult the coil design

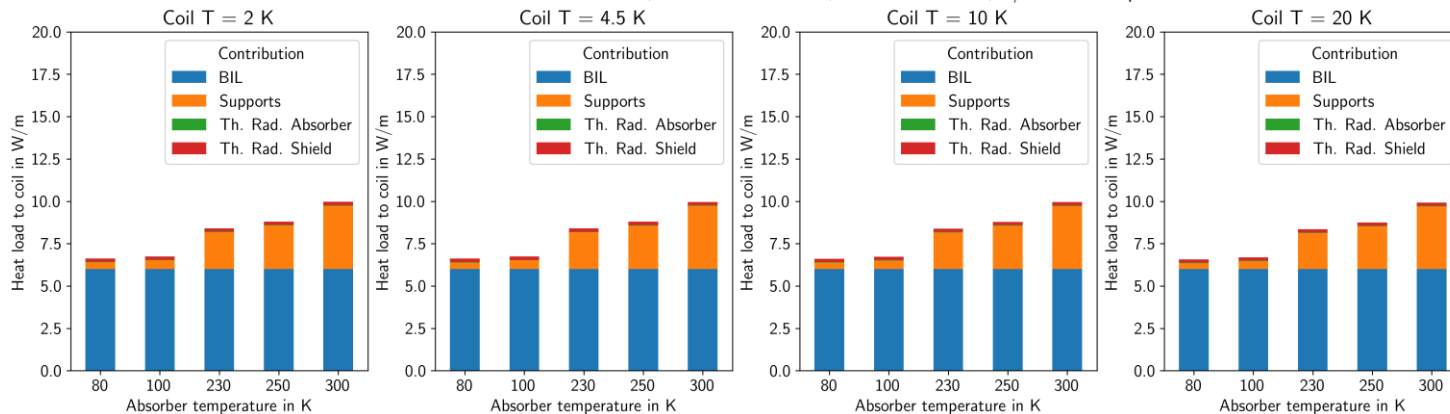
**N.B. I:** For assumptions on calculation of cooling effort from heat loads, see spare slides

**N.B. II:** the cost to extract heat at 300 K is nearly zero, reflecting the fact that the distribution effort (circulation) is **not yet included**

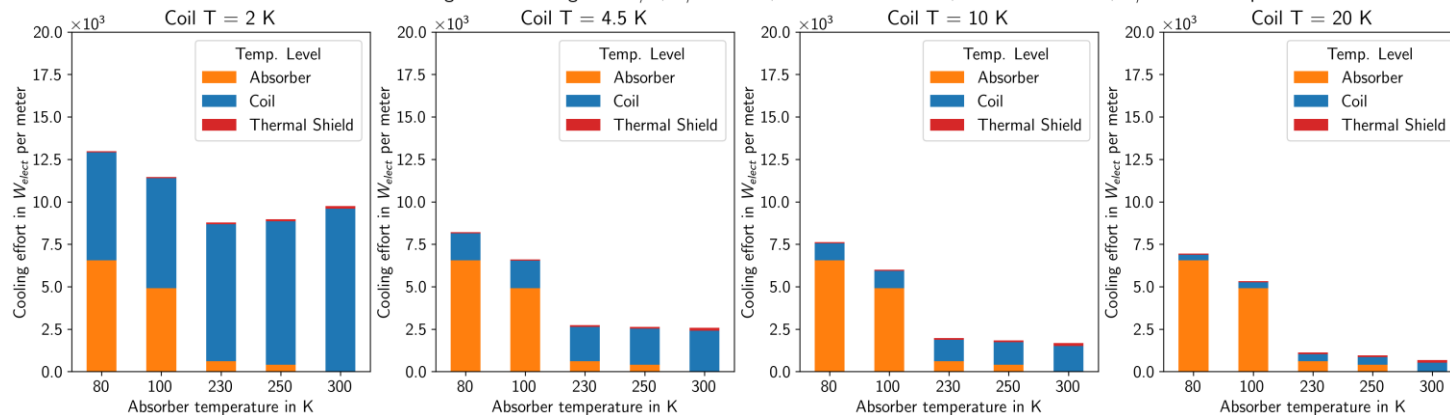
**N.B. III:** although COP<sup>-1</sup> based on cryoplants using certain fluids, so far, we're talking only about temp. level, *i.e.*, no fluid-dependent costs considered (as distribution, special handling, etc...)

# Calculations for a 3 TeV machine, abs. 3 cm

Heat load to coil, abs. thick. = 0.03 m, th. shield = 80 K, w/ heat intercept at  $T = 80$  K



Cooling effort at refrigerator 1/F, w/o distrib., abs. thick. = 0.03 m, th. shield = 80 K, w/ heat intercept at  $T = 80$  K



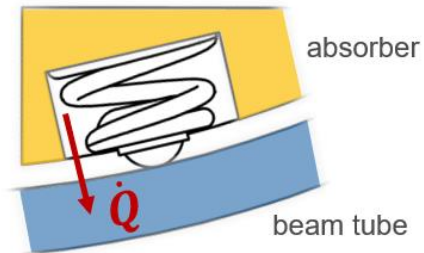
# (Possible) solution for absorber supports from existing implementations

## PUMA rolls

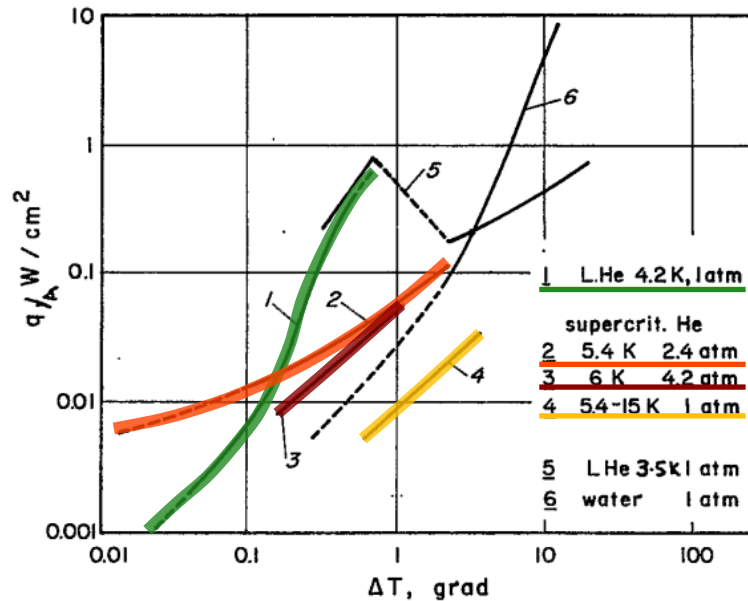
- Heat transfer measurements by J. Liberadzka-Porret at the Cryolab, EMDS # 2443998 ([link](#))  
 $\approx 1$  W/roll under 500 N from RT to LN<sub>2</sub>  
 $\approx 0.1$  W/roll under 500 N from LN<sub>2</sub> to LHe

## HL-LHC beam screen springs

- Heat transfer measurements at the Cryolab, EMDS # 2042522 ([link](#))  
 $\approx 0.05$  W/roll under 15 N from RT to LHe



# Two- vs. single-phase flow local heat extraction Implications for magnet design



- Heat transfer coefficient  $\alpha$  in **liquid He** is  $O(1) - O(2)$  higher than options using high-speed, high-pressure gas/**supercritical fluid**
- If **heat exchange area is limited**, choice of **cooling strategy needs to be adapted** to provide the best possible heat transfer coefficient
- Magnet design** should strive to incorporate, **from the start, heat extraction pathways** as close as possible to the coil and **maximise heat transfer exchange area**

# Power consumption at refrigerator I/F

## From heat loads to power consumption

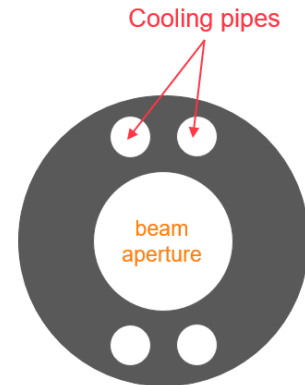
- For each temperature level of absorber, cold mass, and external thermal shield, the inverse coefficient of performance ( $COP^{-1}$ ) at refrigerator interface was estimated to give a semi-realistic power consumption per meter of collider magnet.
- The heat load from each temp. level (slides 9/10) is multiplied by the  $COP^{-1}$  to give a total electrical cost
- Distribution (e.g. pumps to circulate fluids) is not yet included in the “bill”
- Considerations:

Temperature level	$COP^{-1}$ in $W_{\text{elect}}/W_{\text{cool}}$	Source
250 K	1	CO <sub>2</sub> plant ATLAS ITk
100 K	12	LN <sub>2</sub> plant ATLAS
80 K	16	LN <sub>2</sub> plant ATLAS
20 K	50	20 K/50 kW plot Frey (see spares)
10 K	150	LHC cryoplant data
4.5 K	240	LHC cryoplant data
2.0 K	960	LHC cryoplant data

# (rough) estimation of distribution losses

## Absorber

- Calculations for the absorber circuit, 500 W/m
- Considered 2 and 4 pipes in absorber, each of i.d. = 20 mm (half of absorber thickness)
- Cell length** (distance between jumpers to QRL) **fixed at 25 m**, sector **fixed at 1000 m** = 40 cells



Through QRL

Through absorber cooling pipes

	<i>m</i> per sector in kg/s	System pressure in bara	$\Delta p$ per cell in bar (2 pipes)	$\Delta p$ per cell in bar (4 pipes)
N <sub>2</sub> at 80 K (2P)	3.4	1.3	0.9	0.5
N <sub>2</sub> at 100 K (2P)	4.2	2.8	0.2	0.1
CO <sub>2</sub> at 230 K (2P)	2.0	8.9	4.4	2.2
CO <sub>2</sub> at 250 K (2P)	2.3	17.9	2.2	1.1
H <sub>2</sub> O at 300 K (SP)	24.0	3	0.2	0.05

→ pressure drop too high ( $p_{out} < p_{atm}$ )

→ return of QRL dp (barely) within limits

→ pressure drop too high, CO<sub>2</sub> solidifies  
issue for return of QRL (high dp)

→ return of QRL dp within limits

# Proposed work program

- Currently **no work program specifically defined for cryo developments**
- However, a few items have been identified as being of interest:
  - Use of extrapolated flow pattern maps (from CO<sub>2</sub>) needs to be validated for two-phase flow in He and H<sub>2</sub>
  - Explore the limits of heat transfer and pressure drop for sc He cooling
  - Investigation into cryoplant capabilities, deliverable  $\dot{m}$  and  $\dot{Q}_{cooling}$
  - Assessment if H<sub>2</sub> cooling is feasible, implications on safety
  - Design of optimized supports and heat intercept for absorber

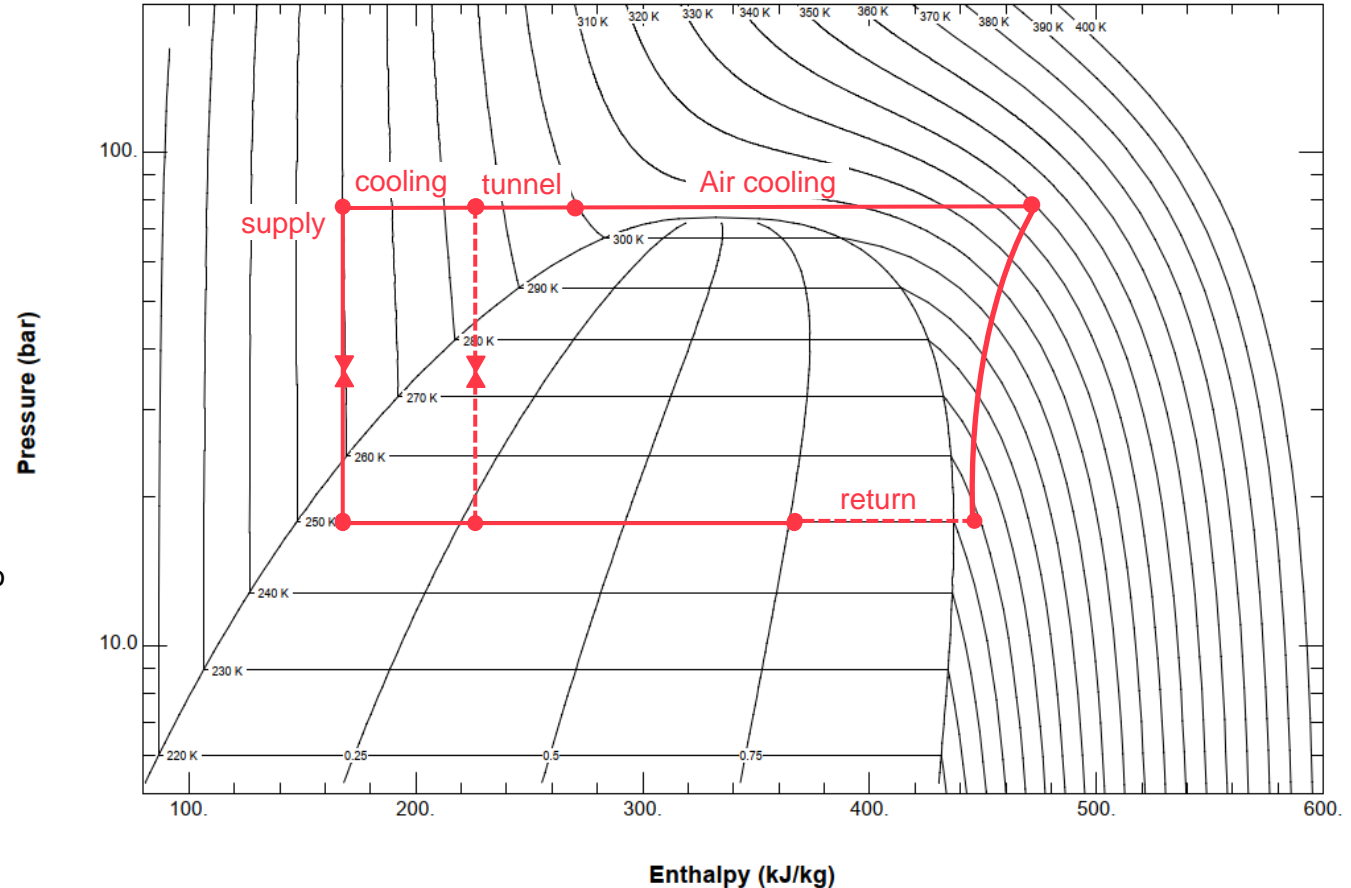




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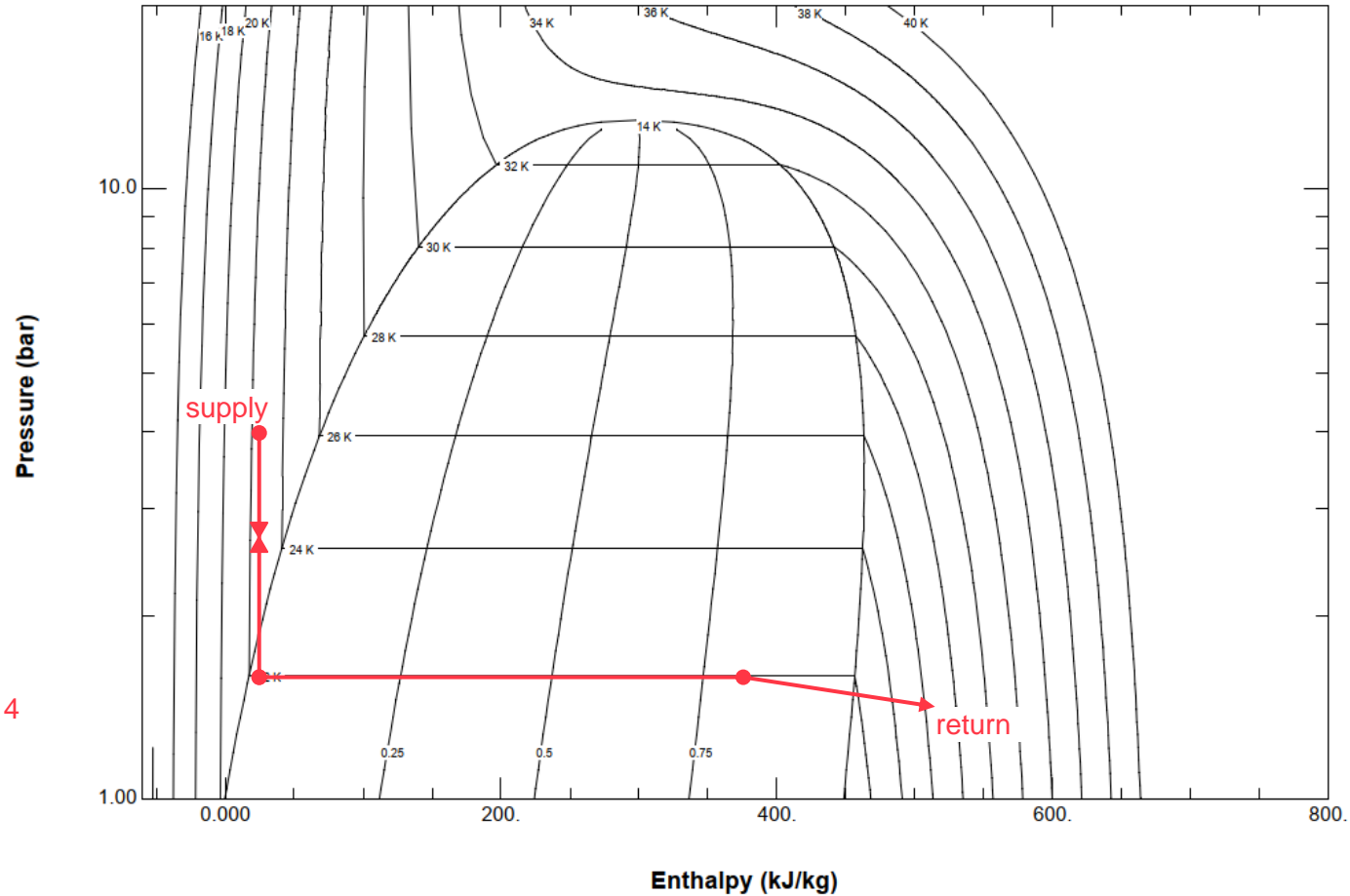
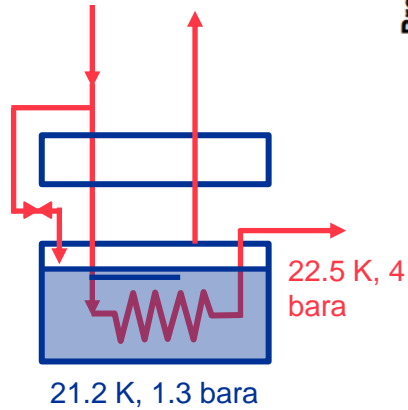
# Carbon Dioxide

- Two-phase flow at 250 K, 20 bara, expanded from 70 bara, 260 K
- Depending how we enter the two-phase region, cooling at “tunnel” or room temperature would be sufficient
- Other cooling schemes possible, to be investigated



# Hydrogen

- Supply subcooled liquid at 4 bara, 22.5 K, expand to 1.3 bara into the two-phase region, two-phase cooling at 21.2 K



# Helium

- Expand from 3 to 1.3 bara into the two-phase region, two-phase cooling at 4.5 K (red)
- Use supercritical region allowing a certain temperature gradient (shown 4.5 K to 5.5 K) (blue)

